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(12) **United States Design Patent**  
**Son**

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(54) **EARSET**

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USPC ..... **D14/223**

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USPC ..... D14/223; 181/129, 130, 135; 379/430,  
379/431; 381/380, 381, 384, 370; 455/575.2,  
455/569.1  
See application file for complete search history.

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(57) **CLAIM**

The ornamental design for a earset, as shown and described.

**DESCRIPTION**

FIG. 1 is a perspective view of earset, showing our new design;  
FIG. 2 is a front elevational view thereof;  
FIG. 3 is a rear elevational view thereof;  
FIG. 4 is a left side elevational view thereof;  
FIG. 5 is a right side elevational view thereof;  
FIG. 6 is a top plan view thereof; and,  
FIG. 7 is a bottom plan view thereof.

**1 Claim, 7 Drawing Sheets**

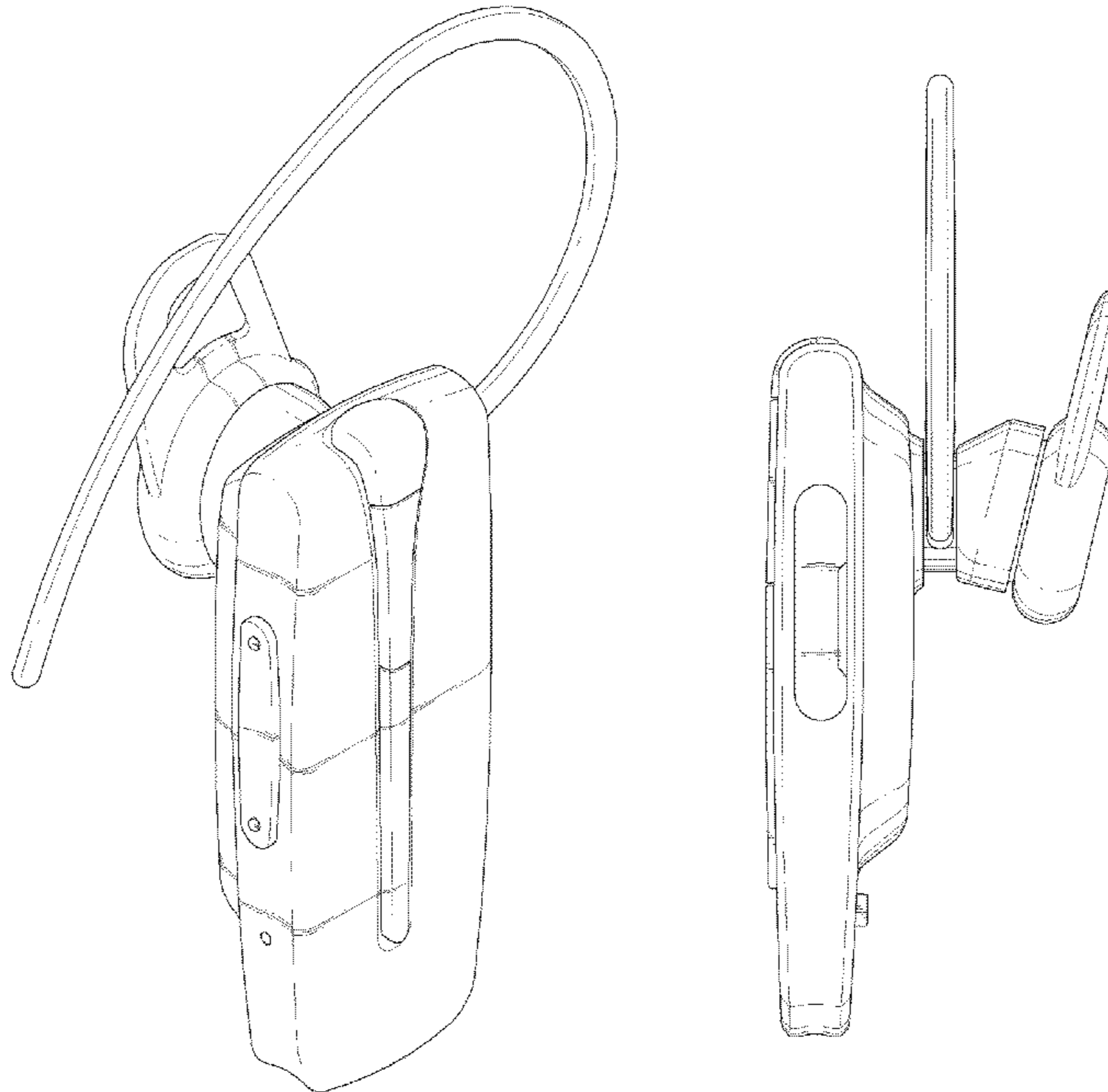


FIG. 1

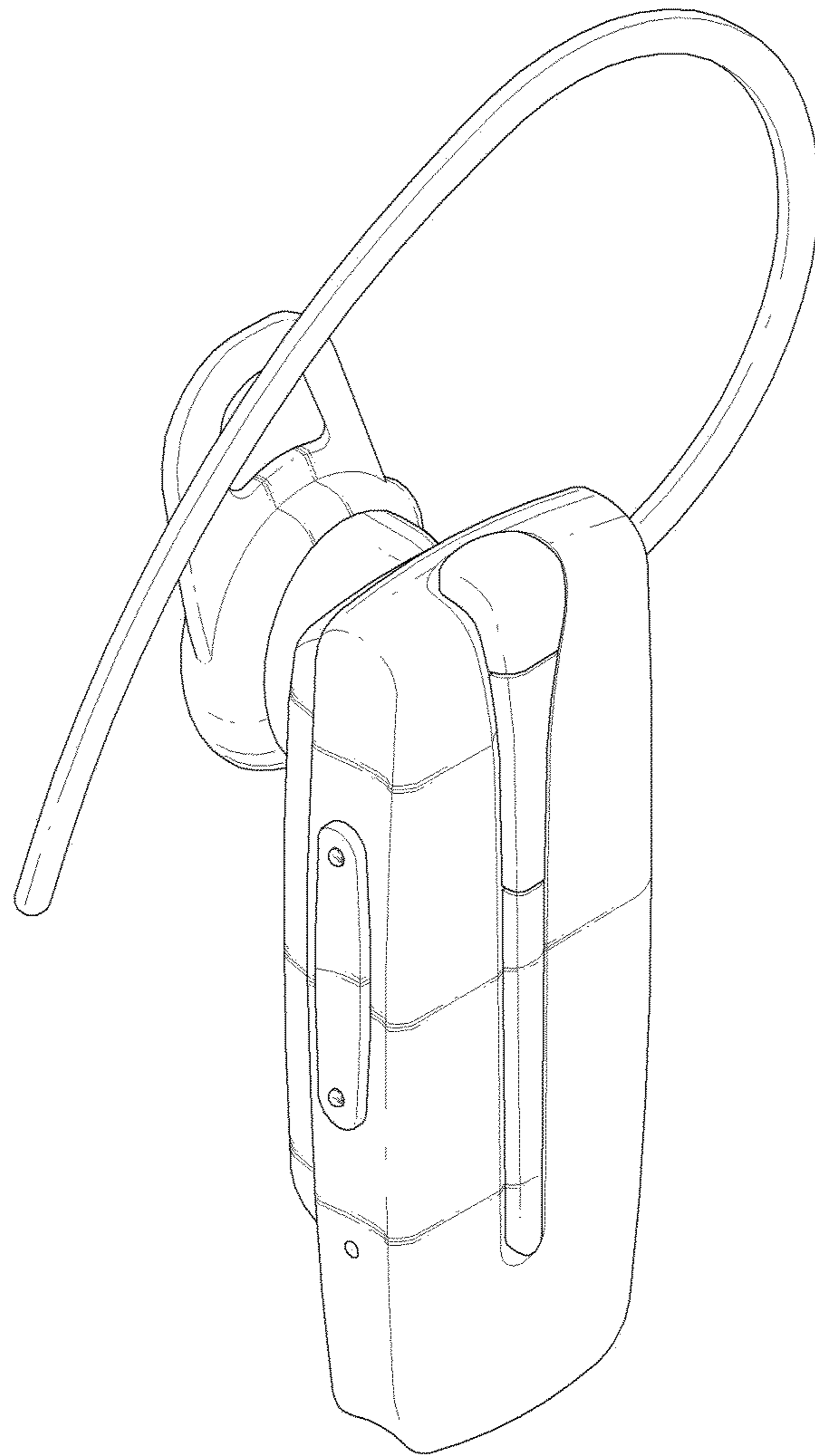


FIG. 2

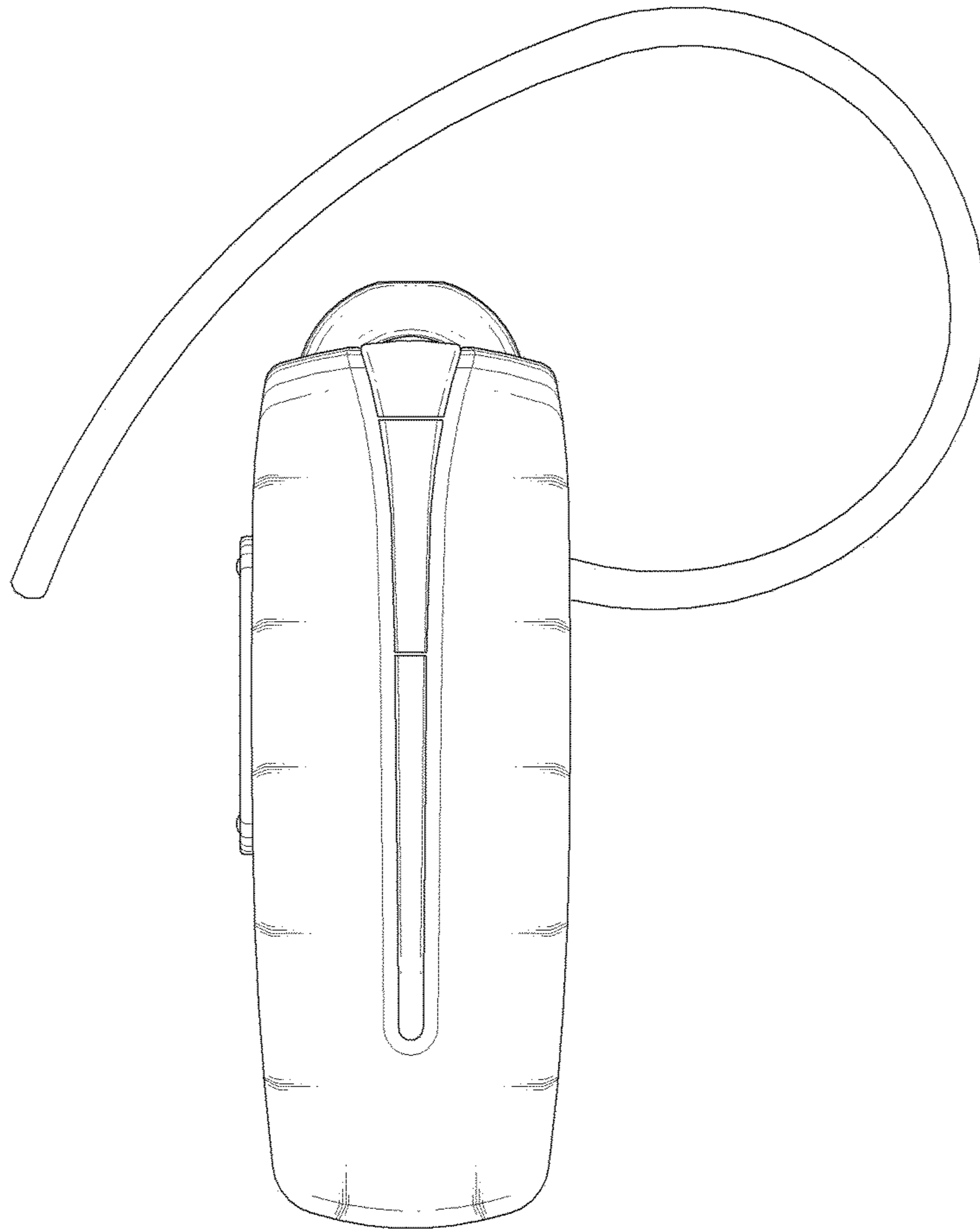


FIG. 3

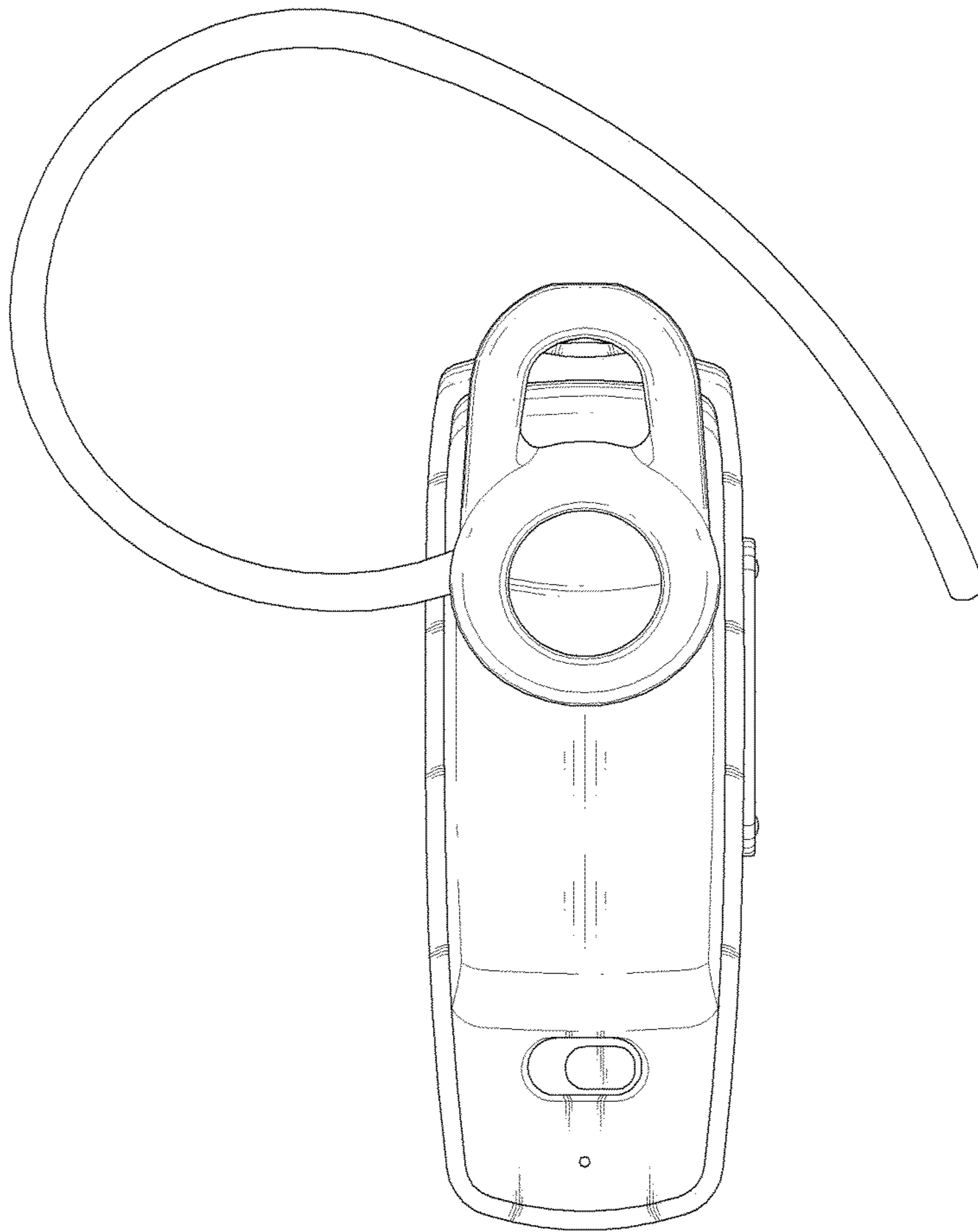


FIG. 4

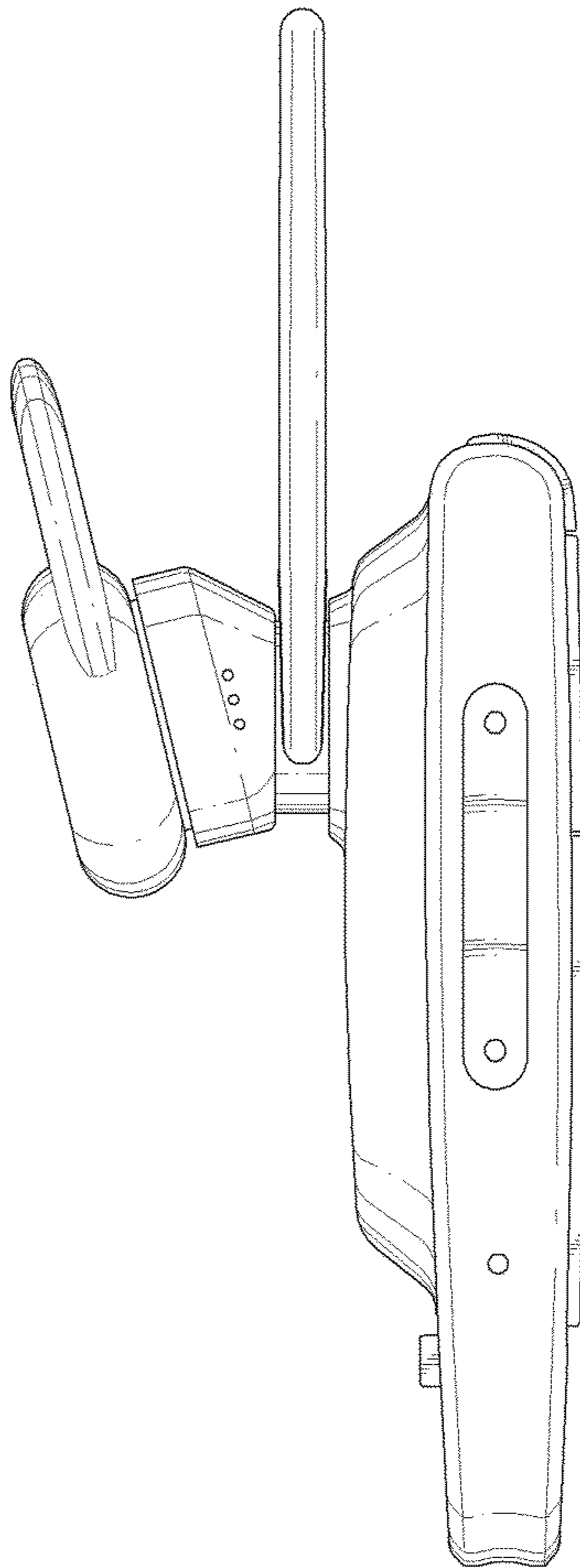


FIG. 5

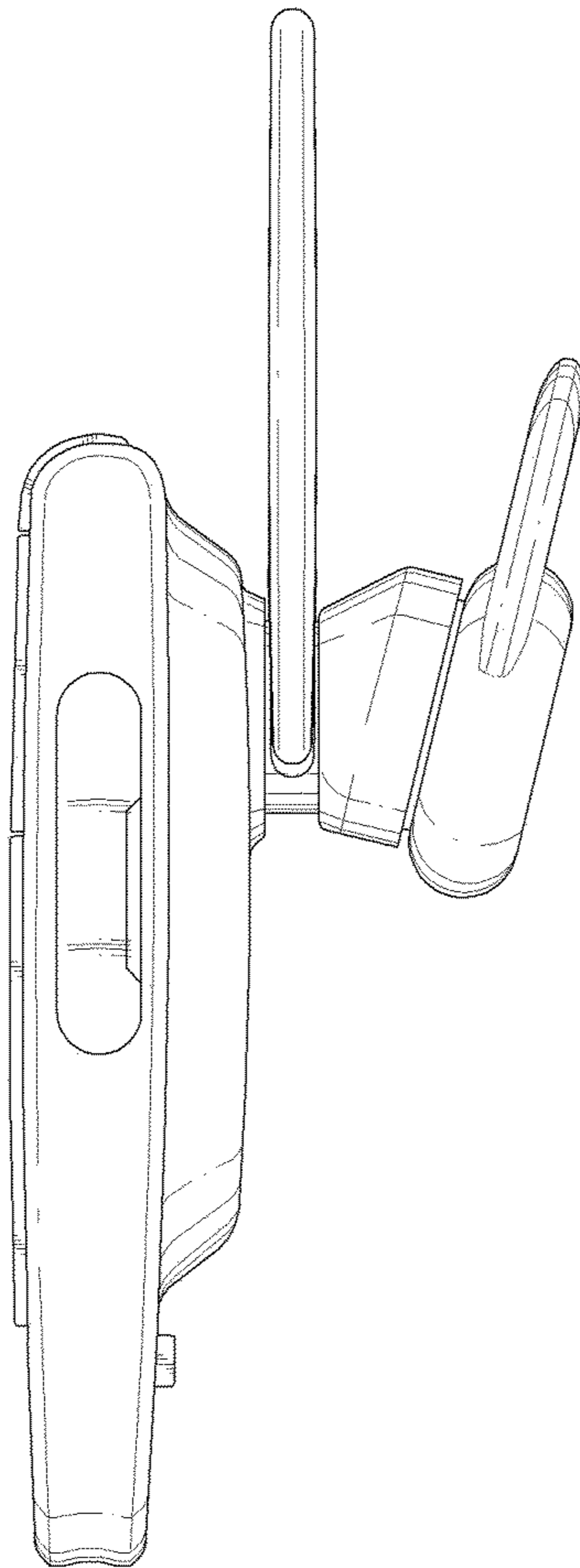


FIG. 6

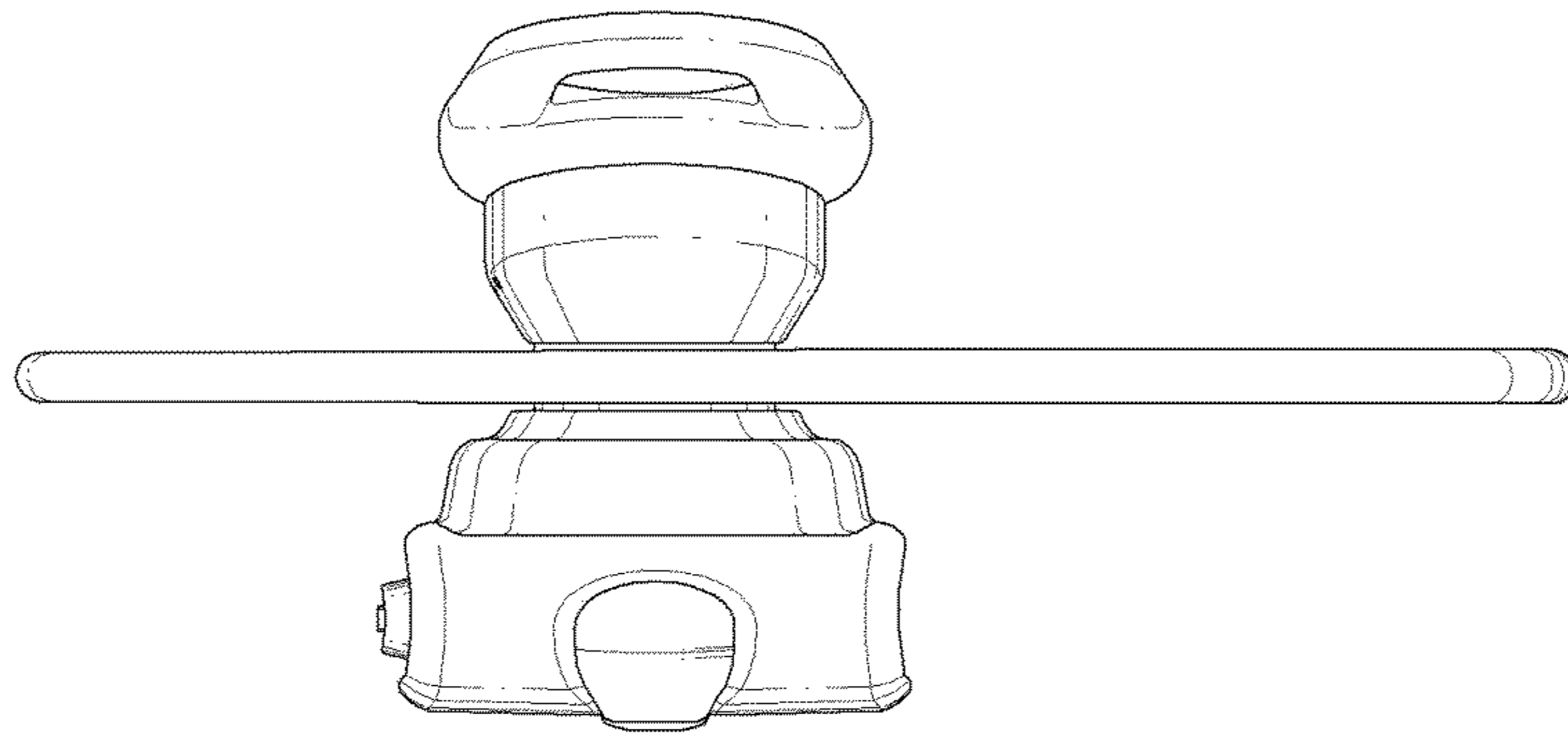


FIG. 7

